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PATENT APPLICATION
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Docket No: Q63598

Tomoki HIROTA

Appln. No.: 09/813,992

Group Art Unit: 2812

Confirmation No.: 2670

Examiner: Jennifer M. KENNEDY

Filed: March 22, 2001

For: METHOD OF AND APPARATUS FOR CUTTING OFF FUSE ELECTRODE,
 INTEGRATED CIRCUIT DEVICE, AND METHOD OF MANUFACTURING SAME

AMENDMENT UNDER 37 C.F.R. § 1.111

Commissioner for Patents
Washington, D.C. 20231

Sir:

In response to the Office Action dated November 19, 2002, please amend the above-identified application as follows:

IN THE CLAIMS:

Please add the following new claims:

11. (New) An integrated circuit device comprising:

B
a plurality of fuse electrodes arrayed parallel to each other with a pitch that is smaller than a spot diameter of a laser beam to be used for cutting said fuse electrodes; and

an insulating film covering said fuse electrodes, said insulating film having a thickness which prevents said laser beam from damaging said fuse electrodes, except for a plurality of